



Differential, Compensated Pressure Sensor (0 to 10 kPa)

MPXC201xDT1

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The MPXC201xDT1 provides a cost-effective, high-volume miniature pressure sensor package targeting medical applications.

- Provides an ideal solution for sub-module components or disposable units
- Uses our sensor die with its piezoresistive technology along with the added feature of on-chip, thin-film temperature compensation and calibration
- Enables flexibility and cost savings in system designs

MPXC201XDT1_BD Block Diagram

PACKAGING ORDERING INFORMATION

Device Type	Packing Options	Case
MPXC2011DT1	Chip Pak, 1/3 Gel	423A
MPXC2012DT1	Chip Pak, No Gel	423A

View additional information for [Differential, Compensated Pressure Sensor \(0 to 10 kPa\)](#).

Note: The information on this document is subject to change without notice.

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